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| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
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| 10/614,462 | 07/07/2003 | Tzu-Chiang Sung | 252011-1490 | 7583 |

47390 7590 12/14/2005

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| EXAMINER |
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LANDAU, MATTHEW C

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| ART UNIT | PAPER NUMBER |
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2815

DATE MAILED: 12/14/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/614,462

Applicant(s)

SUNG ET AL.

Examiner

Matthew Landau

Art Unit

2815

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 21 November 2005.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-3,5,7-11,13,15-17,19,21-25,27 and 29-34 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-3,5,7-11,13,15-17,19,21-25,27 and 29-34 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
- ☐ Certified copies of the priority documents have been received.
 - ☐ Certified copies of the priority documents have been received in Application No. _____.
 - ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Allowable Subject Matter

The indicated allowability of claims 8-11, 13, 22-25, and 27 is withdrawn in view of the newly discovered reference(s) to Williams' 608. Rejections based on the newly cited reference(s) follow.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 1-3, 5, 7, 15-17, 19, 21, and 29-33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Akaishi et al. (US Pat. 6,207,518, hereinafter Akaishi) in view of Williams et al. (US Pat. 5,055,896, hereinafter Williams).

Regarding claims 1, 7, 15, 21, 29, and 33, Figures 1-8 and 10A of Akaishi discloses a high voltage device comprising: a substrate 21; first and second wells (3 and 22, respectively) respectively of a first type (p-type) (Fig. 6) and a second type (n-type) in the substrate; a gate (30/7/36) formed on a junction between the first and second wells, first and second doped regions (4 and 5, respectively), respectively formed in the first and second wells and on both sides of the gate; a third doped region 12 of the first type in the first well and adjacent to the first doped region; and a fourth lightly doped region (LDD, not labeled) of the second type adjacent to the first doped region and beneath the gate (col. 6, lines 23-33), wherein the fourth lightly

Art Unit: 2815

doped region is shallower than the first doped region. The difference between Akaishi and the claimed invention is having no field oxide between the gate and the first and second wells.

Figure 2 of Williams discloses an LDMOS transistor using a field plate 34 instead of a field oxide between the gate 18 and the drain drift region 10. In view of such teaching, it would have been obvious to the ordinary artisan at the time the invention was made to modify the invention of Akaishi by using a field plate instead of a field oxide region between the gate and the second well for the purpose of reducing stress created defects in the crystalline structure at the drift region/channel interface (col. 2, lines 47-51 of Williams). Regarding claim 15, Akaishi in view of Williams also discloses the method of making the above device.

Regarding claims 2, 16, and 30, Figure 8 of Akaishi discloses field oxides 9 isolating the high voltage device from other devices on the substrate.

Regarding claims 3, 17, and 31, Figures 1-8 Akaishi disclose the gate (30/7/36) comprises a gate oxide 30 on the substrate 21, a conducting layer 7 on the gate oxide, and spacers 36 on two sides of the gate oxide and the conducting layer.

Regarding claims 5, 19, and 32, Figure 8 of Akaishi discloses there is a spacing of the second doped region 5 to the gate.

Claims 8, 22, and 34 are rejected under 35 U.S.C. 103(a) as being unpatentable over Akaishi in view of Williams as applied to claim 1 above, and further in view of Williams et al. (US Pat. 5,514,608, hereinafter Williams'608).

Art Unit: 2815

Regarding claims 8, 22, and 34, Akaishi discloses the device shown in Figure 10A can be a p-type transistor by reversing the conductivity types (col. 3, lines 38-42). When the conductivity types are reversed, the first and second types are N and P types, respectively. A further difference between Akaishi and the claimed invention is an N⁺ buried layer in the substrate and beneath the first and second wells. Figure 5 of Williams'608 discloses a LDMOS transistor with a buried layer 504 beneath a gate 509 and first and second wells (503 and N-drift, respectively), wherein the buried layer has the opposite conductivity type as that of the source and drain regions (502 and 507, respectively). Note that Williams'608 discloses the conductivity types shown in Figure 5 can be reversed (col. 9, lines 39-44), meaning the buried layer is n-type. In view of such teaching, it would have been obvious to the ordinary artisan at the time the invention was made to further modify the invention of Akaishi by including an N⁺ buried layer for the purposed of increasing the breakdown voltage (col. 2, lines 55-59 of Williams'608).

Claims 9-11, 13, 23-25, and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Akaishi in view of Williams, Ito et al. (US Pat. 5,856,695, hereinafter Ito), and Williams'608.

Regarding claims 9 and 23, Figures 1-8 of Akaishi discloses a high voltage device formed on a P substrate 1 comprising: a an HVNMOS comprising: first P and N wells (3 and 22, respectively) in the substrate; a first gate (30/7/36) formed on a junction between the first P and N wells, two first N⁺ doped regions (4 and 5) respectively formed in the first P and N wells and

Art Unit: 2815

on both sides of the first gate; a first P⁺ doped region 12 in the first P well and adjacent to the first N⁺ doped region in the first P well; and an N lightly doped region (LDD, not labeled) adjacent to the first N⁺ doped region in the first P well and beneath the first gate (col. 6, lines 23-33). A difference between Akaishi and the claimed invention is having no field oxide between the gate and the first P and N wells. Figure 2 of Williams discloses an LDMOS transistor using a field plate 34 instead of a field oxide between the gate 18 and the drain drift region 10. In view of such teaching, it would have been obvious to the ordinary artisan at the time the invention was made to modify the invention of Akaishi by using a field plate and no field oxide region between the gate and the first N well for the purpose of reducing stress created defects in the crystalline structure at the drift region/channel interface (col. 2, lines 47-51 of Williams). A further difference between Akaishi and the claimed invention is an HVPMOS device formed in the P substrate, wherein the HVPMOS has essentially the same structure but opposite conductivity types. Figure 23 of Ito discloses both an HVNMOS and an HVPMOS formed on a P substrate, wherein the HVNMOS and HVPMOS have essentially the same structure but opposite conductivity types. In view of such teaching, it would have been obvious to the ordinary artisan at the time the invention was made to further modify the invention of Akaishi by including an HVPMOS having the same structure as that of the HVNMOS (but oppositely doped) on the P substrate as taught by Ito. The ordinary artisan would have been motivated to further modify Akaishi in the manner described above for the purpose of increasing integration density while increasing the versatility of the device (by forming a CMOS device). The advantage of CMOS devices is well known in the art. A further difference between Akaishi and the claimed invention is having an N⁺ buried layer in HVPMOS device. Figure 5 of Williams'608 discloses a LDMOS

Art Unit: 2815

transistor with a buried layer 504 beneath a gate 509 and first and second wells (503 and N-drift, respectively), wherein the buried layer has the opposite conductivity type as that of the source and drain regions (502 and 507, respectively). Note that Williams'608 discloses the conductivity types shown in Figure 5 can be reversed (col. 9, lines 39-44), meaning the buried layer is n-type. In view of such teaching, it would have been obvious to the ordinary artisan at the time the invention was made to further modify the invention of Akaishi by including an N+ buried layer for the purposed of increasing the breakdown voltage (col. 2, lines 55-59 of Williams'608).

Regarding claim 23, the above device must be made by the claimed method.

Regarding claims 10 and 24, Figure 8 of Akaishi discloses field oxide regions 9 isolating the devices from other devices on the substrate.

Regarding claims 11 and 25, Figures 1-8 of Akaishi disclose each of the first and second gates (30/7/36) comprises a gate oxide 30 on the substrate 21, a conducting layer 7 on the gate oxide, and spacers 36 on two sides of the gate oxide and the conducting layer.

Regarding claims 13 and 27, Figure 8 of Akaishi discloses there is a spacing of the first N+ doped region 5 in the first N well to the first gate and the second P+ doped region (same as region 5) in the second P well to the second gate.

Response to Arguments

Applicant's arguments with respect to claims 1 and 15 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

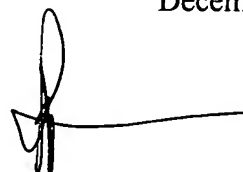
Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew C. Landau whose telephone number is (571) 272-1731.

The examiner can normally be reached from 8:30 AM - 5:30 PM. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kenneth Parker can be reached on (571) 272-2298. The fax phone numbers for the organization where this application or proceeding is assigned are (571) 273-8300 for regular communications and (571) 273-8300 for After Final communications.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should any questions arise regarding access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Matthew C. Landau

December 11, 2005

A handwritten signature in black ink, appearing to read 'SFE Kenneth Parker', with a long horizontal stroke extending to the right.

SFE Kenneth Parker
T22800